# 74LVC2245A

Octal transceiver with direction pin, 30  $\Omega$  series termination resistors; 5 V tolerant input/output; 3-state

Rev. 5 — 4 November 2011

**Product data sheet** 

# 1. General description

The 74LVC2245A is a octal transceiver featuring non-inverting 3-state bus compatible outputs in both send and receive directions.

A send/receive (DIR) input controls direction, and an output enable  $(\overline{OE})$  input makes easy cascading possible. Pin  $\overline{OE}$  controls the outputs so that the buses are effectively isolated.

It is a high-performance, low-power, low-voltage, Si-gate CMOS device and superior to most advanced CMOS compatible TTL families.

The device is designed with 30  $\Omega$  series termination resistors in both HIGH and LOW output stages to reduce line noise.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V and 5 V applications.

## 2. Features and benefits

- 5 V tolerant inputs/outputs, for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- Direct interface with TTL levels
- Integrated 30  $\Omega$  termination resistors
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - ◆ JESD8-5A (2.3 V to 2.7 V)
  - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115B exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



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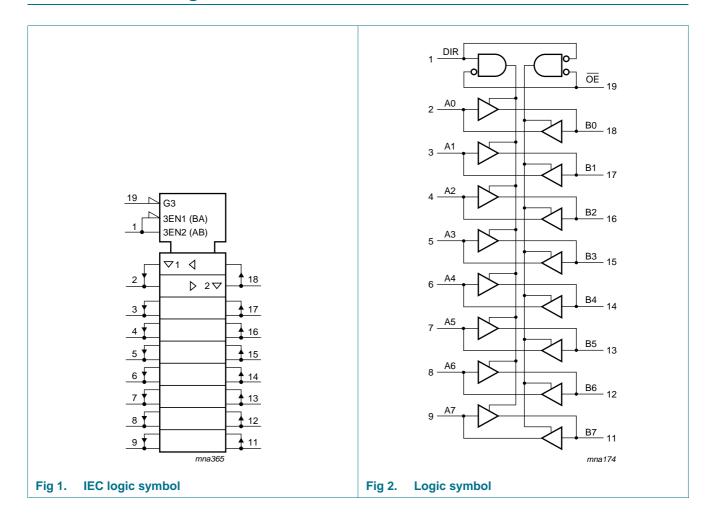
# Octal transceiver with direction pin, 30 $\Omega$ series termination resistors

# 3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC2245AD	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1
74LVC2245ADB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1
74LVC2245APW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1
74LVC2245ABQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	SOT764-1

# 4. Functional diagram

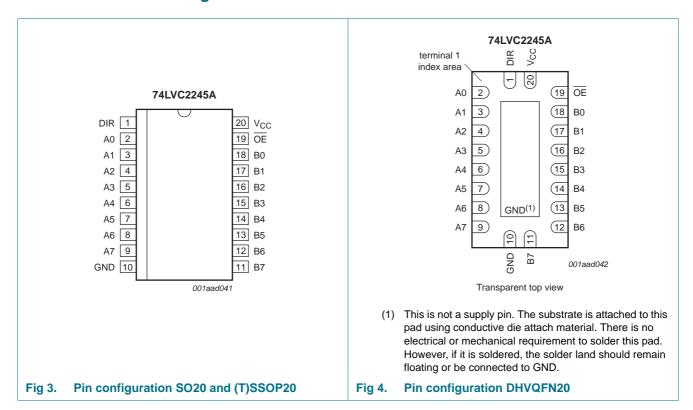


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# **Pinning information**

#### 5.1 Pinning



# 5.2 Pin description

Pin description Table 2.

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Symbol	Pin	Description
DIR	1	direction control input
A[0:7]	2, 3, 4, 5, 6, 7, 8, 9	data input/output
GND	10	ground (0 V)
B[0:7]	18, 17, 16, 15, 14, 13, 12,	11 data input/output
ŌE	19	output enable input (active LOW)
$V_{CC}$	20	supply voltage

# **Functional description**

Table 3. **Functional table** 

Input		Input/output	
OE	DIR	An	Bn
LOW	LOW	A = B	input
LOW	HIGH	input	B = A
HIGH	don't care	Z (high-impedance OFF-state)	Z (high-impedance OFF-state)

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#### Octal transceiver with direction pin, 30 $\Omega$ series termination resistors

# 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
$V_{I}$	input voltage		[ <u>1</u> ] -0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$	-	±50	mA
Vo	output voltage	output HIGH or LOW state	[2] -0.5	$V_{CC} + 0.5$	V
		output 3-state	[ <u>2</u> ] -0.5	+6.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
$I_{GND}$	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	<u>[3]</u> _	500	mW

<sup>[1]</sup> The minimum input voltage ratings may be exceeded if the input current ratings are observed.

# 8. Recommended operating conditions

Table 5. Recommended operating conditions

Parameter	Conditions	Min	Тур	Max	Unit
supply voltage		1.65	-	3.6	V
	functional	1.2	-	-	V
input voltage		0	-	5.5	V
output voltage	output HIGH or LOW state	0	-	$V_{CC}$	V
	output 3-state	0	-	5.5	V
ambient temperature		-40	-	+125	°C
input transition rise	$V_{CC} = 1.65 \text{ V to } 2.7 \text{ V}$	0	-	20	ns/V
and fall rate	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V
	input voltage output voltage ambient temperature	supply voltage  functional  input voltage  output voltage  output HIGH or LOW state  output 3-state  ambient temperature  input transition rise  and fall rate  V <sub>CC</sub> = 1.65 V to 2.7 V	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

<sup>[2]</sup> The output voltage ratings may be exceeded if the output current ratings are observed.

<sup>[3]</sup> For SO20 packages: above 70 °C derate linearly with 8 mW/K.
For (T)SSOP20 packages: above 60 °C derate linearly with 5.5 mW/K.
For DHVQFN20 packages: above 60 °C derate linearly with 4.5 mW/K.

# 9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	<b>-40</b>	°C to +8	5 °C	–40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
$V_{IH}$	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	Min   Typ(1)   Max   Min   No   No   No   No   No   No   No   N	-	V			
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	-	0.7	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V
$V_{OH}$	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$						
	output voltage	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	V <sub>CC</sub> – 0.2	$V_{CC}$	-	V <sub>CC</sub> – 0.3	-	V
		$I_{O} = -2 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_O = -4$ mA; $V_{CC} = 2.3$ V	1.8	-	-	1.65	-	V
		$I_O = -6$ mA; $V_{CC} = 2.7$ V	2.2	-	-	2.05	-	V
		$I_{O} = -9 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	-	0.2	-	0.3	V
		$I_O = 2 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_0 = 4 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_0 = 6 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_O = 12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I <sub>I</sub>	input leakage current	$V_{CC} = 3.6 \text{ V}; V_I = 5.5 \text{ V or GND}$	-	±0.1	±5	-	±20	μΑ
l <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 3.6$ V; $V_O = 5.5$ V or GND;	-	±0.1	±5	-	±20	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_{CC} = 0 \text{ V}$ ; $V_I \text{ or } V_O = 5.5 \text{ V}$	-	±0.1	±10	-	±20	μΑ
I <sub>CC</sub>	supply current	$V_{CC}$ = 3.6 V; $V_I$ = $V_{CC}$ or GND; $I_O$ = 0 A	-	0.1	10	-	40	μΑ
Δl <sub>CC</sub>	additional supply current	per input pin; $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V};$ $V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A}$	-	5	500	-	5000	μΑ
Cı	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$	-	4.0	-	-	-	pF

<sup>[1]</sup> All typical values are measured at  $V_{CC}$  = 3.3 V (unless stated otherwise) and  $T_{amb}$  = 25 °C.

#### Octal transceiver with direction pin, 30 $\Omega$ series termination resistors

# 10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

Symbol	Parameter	Conditions		T <sub>amb</sub> =	-40 °C to	+85 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation delay	An to Bn; Bn to An; see Figure 5	[2]						
		V <sub>CC</sub> = 1.2 V		-	26	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		1.8	7.5	17.1	1.8	18.0	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.5	3.9	8.4	1.5	9.4	ns
		V <sub>CC</sub> = 2.7 V		1.5	3.9	7.3	1.5	9.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	3.3	6.3	1.5	8.0	ns
t <sub>en</sub>	enable time	OE to An or Bn; see Figure 6	[2]						
		V <sub>CC</sub> = 1.2 V		-	28	-	-	-	ns
		V <sub>CC</sub> = 1.65 V		2.5	9.5	18.8	2.5	21.0	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.1	5.3	10.3	2.1	11.5	ns
		V <sub>CC</sub> = 2.7 V		1.5	5.4	9.5	1.5	12.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	4.2	8.2	1.5	10.5	ns
t <sub>dis</sub>	disable time	OE to An or Bn; see Figure 6	[2]						
		V <sub>CC</sub> = 1.2 V		-	12.0	-	-	-	ns
		V <sub>CC</sub> = 1.65 V		3.0	5.0	10.2	3.0	11.0	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	2.8	5.8	1.0	6.3	ns
		V <sub>CC</sub> = 2.7 V		1.5	3.6	6.9	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.7	3.3	5.9	1.7	7.5	ns
t <sub>sk(o)</sub>	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
C <sub>PD</sub>	power dissipation	$V_I = GND \text{ to } V_{CC}$	[4]						
	capacitance	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		-	7.7	-	-	-	pF
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ $V_{CC} = 2.7 \text{ V}$ $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ $V_{I} = \text{GND to } V_{CC}$		-	11.3	-	-	-	pF
				-	14.4	-	-	-	pF

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

V<sub>CC</sub> = supply voltage in Volts,

N = number of inputs switching,

$$\Sigma(C_L \times V_{CC}^2 \times f_o)$$
 = sum of the outputs.

<sup>[2]</sup>  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

ten is the same as tPZL and tPZH.

 $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .

<sup>[3]</sup> Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

<sup>[4]</sup>  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $f_i$  = input frequency in MHz,  $f_o$  = output frequency in MHz,

C<sub>L</sub> = output load capacitance in pF,

## Octal transceiver with direction pin, 30 $\Omega$ series termination resistors

# 11. AC waveforms

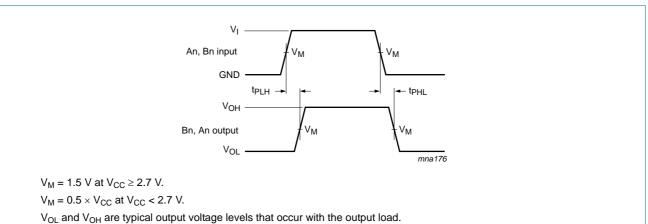
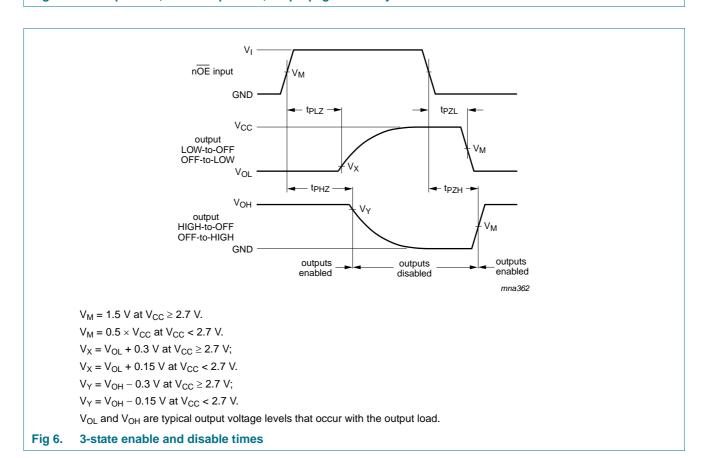
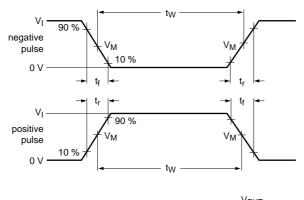
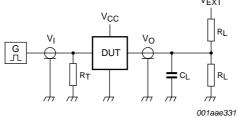


Fig 5. The inputs An, Bn to outputs Bn, An propagation delays



## Octal transceiver with direction pin, 30 $\Omega$ series termination resistors





Test data is given in Table 8.

Definitions for test circuit:

R<sub>L</sub> = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

 $V_{EXT}$  = External voltage for measuring switching times.

Fig 7. Test circuit for measuring switching times

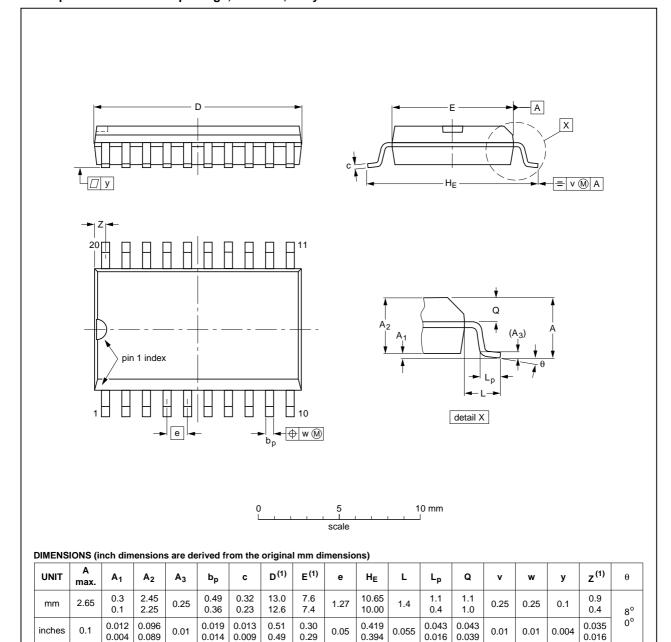
Table 8. Test data

Supply voltage	Input		Load		V <sub>EXT</sub>		
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	$t_{PLZ}$ , $t_{PZL}$	t <sub>PHZ</sub> , t <sub>PZH</sub>
1.2 V	$V_{CC}$	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND
1.65 V to 1.95 V	$V_{CC}$	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND
2.3 V to 2.7 V	$V_{CC}$	≤ 2 ns	30 pF	$500 \Omega$	open	$2\times V_{CC}$	GND
2.7 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	$2\times V_{CC}$	GND
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	$2\times V_{CC}$	GND

# 12. Package outline

#### SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

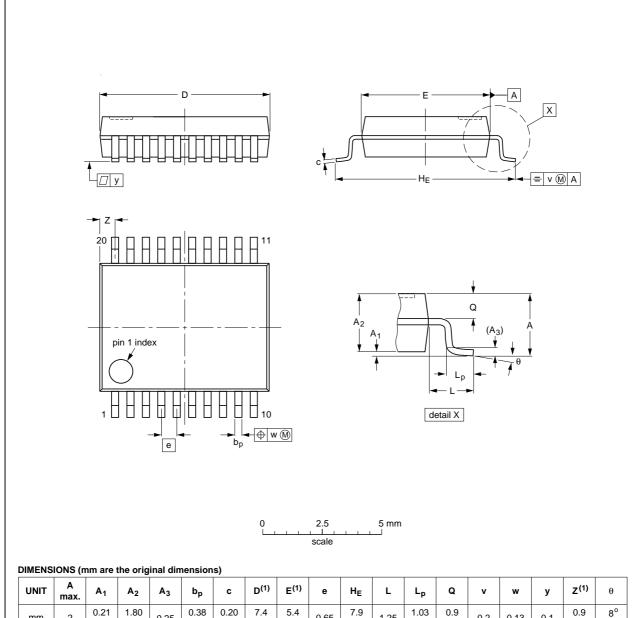
OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	VERSION IEC JEDEC		JEITA		PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013				<del>99-12-27</del> 03-02-19

Fig 8. Package outline SOT163-1 (SO20)

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SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	ø	v	w	у	Z <sup>(1)</sup>	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

#### Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

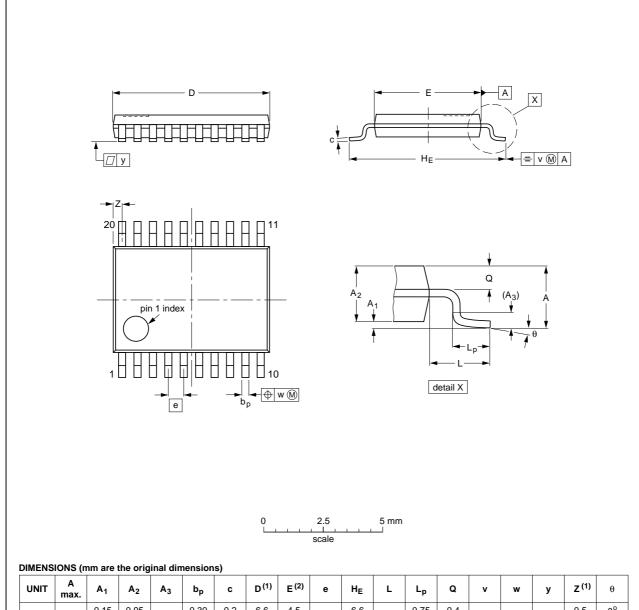
OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT339-1		MO-150			<del>99-12-27</del> 03-02-19

Fig 9. Package outline SOT339-1 (SSOP20)

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TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



 						-,												
UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

	OUTLINE VERSION	REFERENCES			EUROPEAN	ISSUE DATE	
		IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
	SOT360-1		MO-153				<del>99-12-27</del> 03-02-19
	SO1360-1		MO-153				

Fig 10. Package outline SOT360-1 (TSSOP20)

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DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

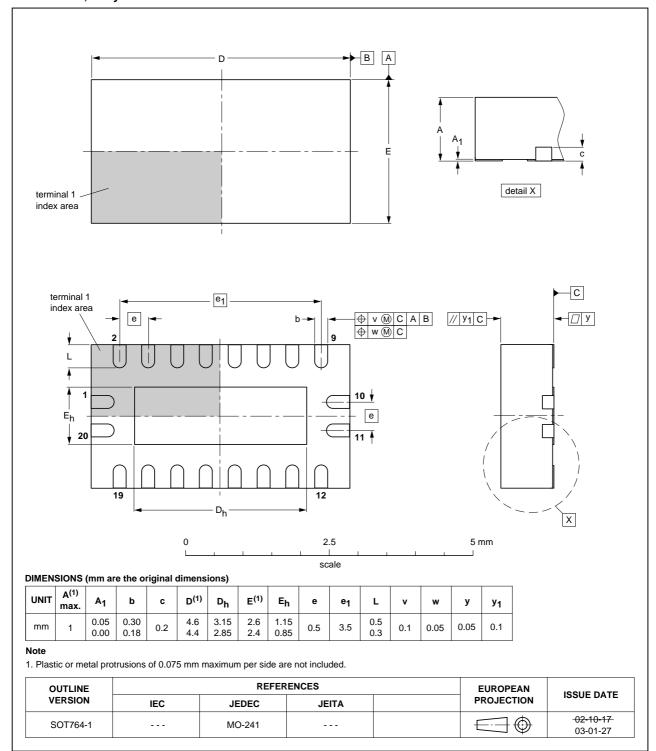


Fig 11. Package outline SOT764-1 (DHVQFN20)

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# Octal transceiver with direction pin, 30 $\Omega$ series termination resistors

# 13. Abbreviations

#### Table 9. Abbreviations

Acronym	Description	
CDM	Charged Device Model	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
HBM	Human Body Model	
MM	Machine Model	
TTL	Transistor-Transistor Logic	

# 14. Revision history

## Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC2245A v.5	20111104	Product data sheet	-	74LVC2245A v.4
Modifications:		of this document has been ref NXP Semiconductors.	edesigned to comply	with the new identity
	<ul> <li>Legal texts h</li> </ul>	nave been adapted to the ne	ew company name v	where appropriate.
	• Table 4, Tabl	<u>le 5, Table 6, Table 7</u> and <u>Ta</u>	able 8: values added	d for lower voltage
	ranges.			
74LVC2245A v.4	20031117	Product specification	-	74LVC2245A v.3
74LVC2245A v.3	20020610	Product specification	-	74LVC2245A v.2
74LVC2245A v.2	19990615	Product specification	-	74LVC2245A v.1
74LVC2245A v.1	19990323	Product specification	-	-

#### Octal transceiver with direction pin, 30 $\Omega$ series termination resistors

# 15. Legal information

#### 15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

#### 15.2 Definitions

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#### Octal transceiver with direction pin, 30 $\Omega$ series termination resistors

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## Octal transceiver with direction pin, 30 $\Omega$ series termination resistors

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